

Electronic Acknowledgement Receipt

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|---|---|
| EFS ID: | 2080652 |
| Application Number: | 10680509 |
| International Application Number: | |
| Confirmation Number: | 5043 |
| Title of Invention: | Adhesive bonding with low temperature grown amorphous or polycrystalline compound semiconductors |
| First Named Inventor/Applicant Name: | Kuang Chien Hsieh |
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| Filer: | Mindy Niedzielka Rittner/Olivia Lopez |
| Filer Authorized By: | Mindy Niedzielka Rittner |
| Attorney Docket Number: | 10322/57 |
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| Application Type: | Utility under 35 USC 111(a) |

Payment information:

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|------------------------|----|
| Submitted with Payment | no |
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File Listing:

| Document Number | Document Description | File Name | File Size(Bytes) /Message Digest | Multi Part /.zip | Pages (if appl.) |
|-----------------|-------------------------------|------------------------|--|------------------|------------------|
| 1 | Miscellaneous Incoming Letter | 1032257Transmittal.pdf | 47604 | no | 1 |
| | | | 62c990f46acd765d3b657e1b1160c59fb9b443 | | |

Warnings:

Information:

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|---|-------------------------------|-----------------------------|--|----|---|
| 2 | Miscellaneous Incoming Letter | 1032257InterviewSummary.pdf | 72562 | no | 3 |
| | | | d311e2526917c5b6b6973ae051fa2a23837be092af | | |

Warnings:

Information:

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| Total Files Size (in bytes): | 120166 |
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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

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